



Notes:
 "DNP" = Do Not Populate
 R3 for test purpose
 Ref. des. > 99 have been added
 Short pin 1 of U3 to PGND on the board



4.5V...16Vin to 3.3V, 5V, 18V @ 60mA each		
Size B	Number PMP7223	Rev A
Date 11/23/2012	Drawn by R. Scibilia	
Filename PMP7223 Rev_B_pads.sch	Sheet 1 of 1	

Engineer R. Scibilia

11/23/2012

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